



Union Internationale Pour La Science, La Technique et Les Applications du Vide
International Union for Vacuum Science, Technique and Applications
Internationale Union für Vakuum Forschung, Technik und Anwendung

The 2019 International M. W. Welch Scholarship Award

Dear IUVSTA Stake-Holder,

Please advertise this **Opportunity for Outstanding Young Scientists to Travel and Work at a Foreign Lab**, the International M. W. Welch Scholarship Award. This award will provide \$15,000 for a young researcher to travel to and work at a lab in another country. "Young" is defined as within one year of a PhD, or up to two years after obtaining a PhD. The duration of the stay is between 3 months and 1 year. The duration depends upon the cost of living of the location chosen and level of the applicant. A partial list of laboratories willing to host the awardee can be found here: <http://iuvsta.org/main/wp-content/uploads/2018/03/Possible-Welch-Scholarship-Hosting-Laboratories-1.xlsx>. Note that this list is not exhaustive, and the candidate is welcome to propose any laboratory which is willing to host the stay.

A link to the application can be found here: <http://iuvsta.org/welch-application/>. It will require uploading a CV, a plan of the research to be done, a letter from the hosting institution, and two reference letters. The successful candidate will be of outstanding merit and have a research plan which will have significant impact on the candidate's career. The first application deadline is: June 15, 2019.

We are hoping to have many applicants to choose from, so please spread the word about this opportunity far and wide. Last year we had 7 applicants and the winner was a person who studied in Hong Kong who is now spending three months in the US. This is an excellent opportunity for young scientists/engineers. Because I am on sabbatical and my emails are generating an auto-reply, please reply to my gmail: davidneilruzic@gmail.com for questions. Thank you very much!

Yours,
David

David N. Ruzic
Abel Bliss Professor of Engineering
Director, Center for Plasma Material Interactions <http://cpmi.illinois.edu>
Nuclear, Plasma and Radiological Engineering
University of Illinois at Urbana-Champaign
Scientific Director of IUVSTA <http://iuvsta.org>
Work: 217-333-0332
Cell: 217-840-3282
